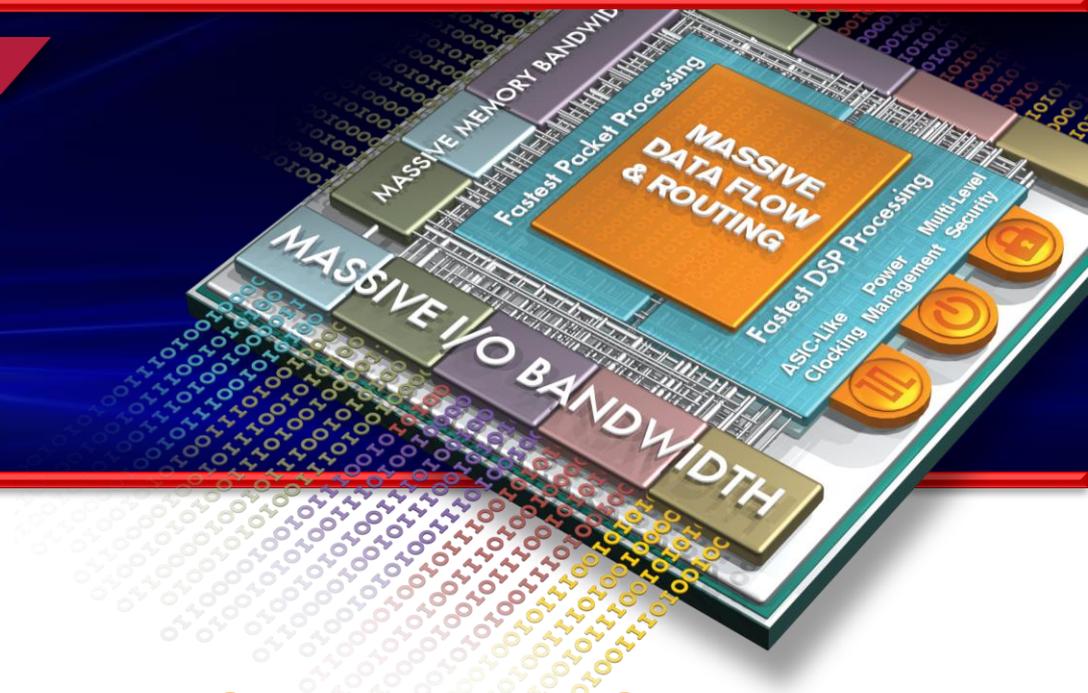


# UltraSCALE™ Architecture



## Enhancements in UltraScale CLB Architecture

# FPGA User Requirements

- **Routability**      **Reduce routing demand**
  - Demand for Increased bandwidth requires more routing resources
- **Device Utilization**      **Allow increased utilization of logic resources**
  - Customer want to use as much of the FPGA to maximize device utilization
- **Performance**      **Reduce contribution of routing delays to critical paths**
  - Routing delays dominate critical paths
- **Power**      **Enable power reduction techniques; reduces dynamic power**
  - Large dynamic power

Changes in FPGA evaluated for positive impact vis-à-vis requirements

UltraScale CLB architecture ...

# UltraScale CLB Architecture Enhancements

## ➤ Several enhancements in UltraScale vis-à-vis 7-Series Architecture

- Enhancements in BRAM, DSP and other logic blocks
- More flexible Clocking
- Improvements in Routing Architecture
- Improved inter-die connectivity
- Larger Carry Chain in CLB
- Larger Multiplexer in CLB

## ➤ We only discuss

- Better access to flops
- Better use of flops

## **CLB changes should result in:**

- **Lower demand for routing resources**
- **Fewer CLBs**
- **Less impact on the QOR due to increased device utilization**

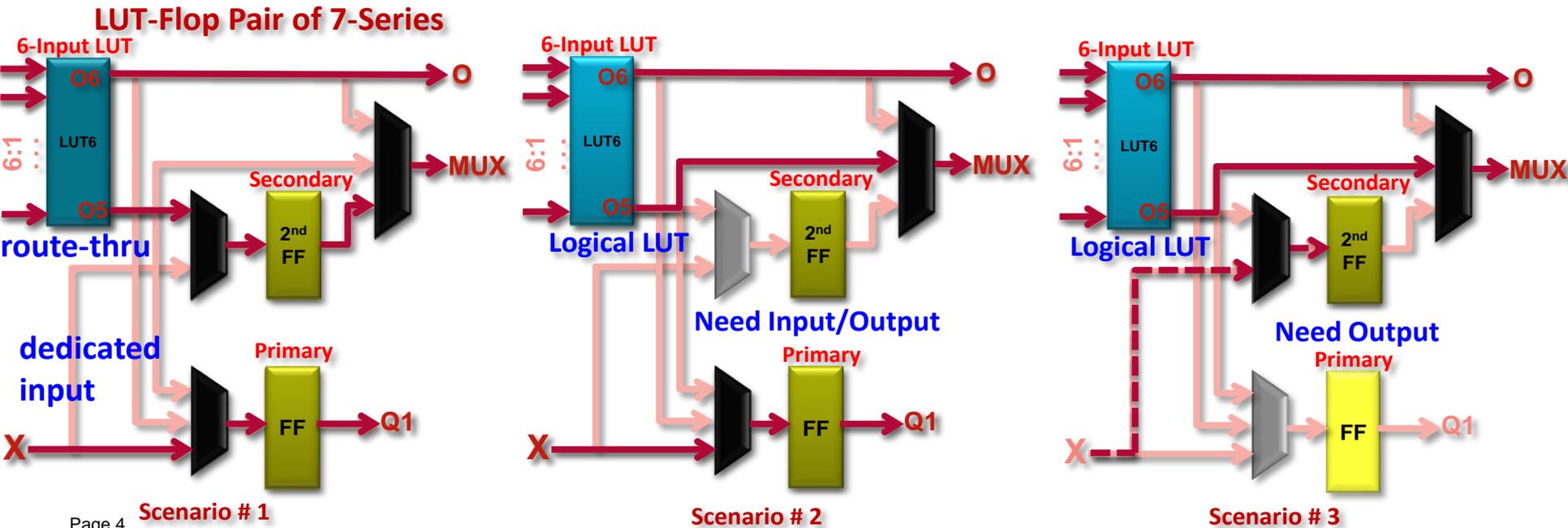
# Opportunities for improvement in 7-Series CLB

## Make flops more *accessible*

### ➤ In 7-Series CLB Architecture:

- “LUT route-thru” needed to access both flops simultaneously
- Extra input/output needed to escape all LUT and Flop outputs simultaneously

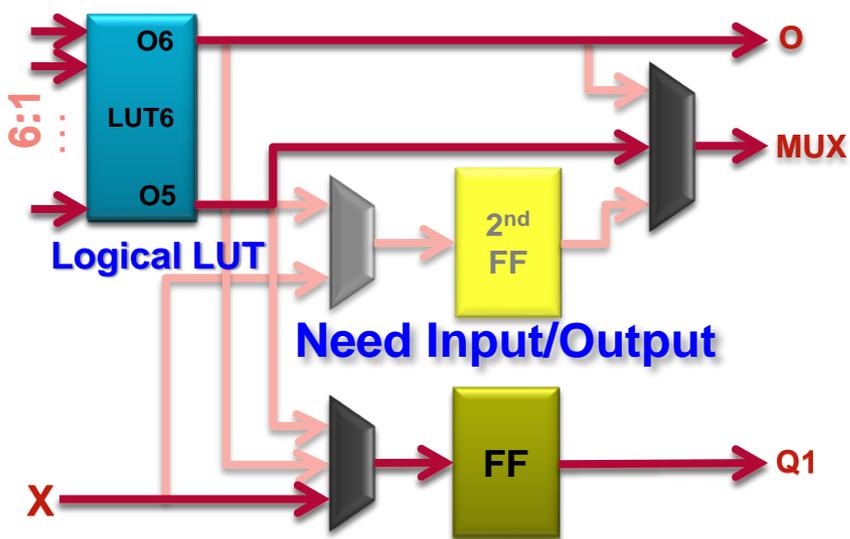
## Opportunity to improve packing in 7-Series CLB



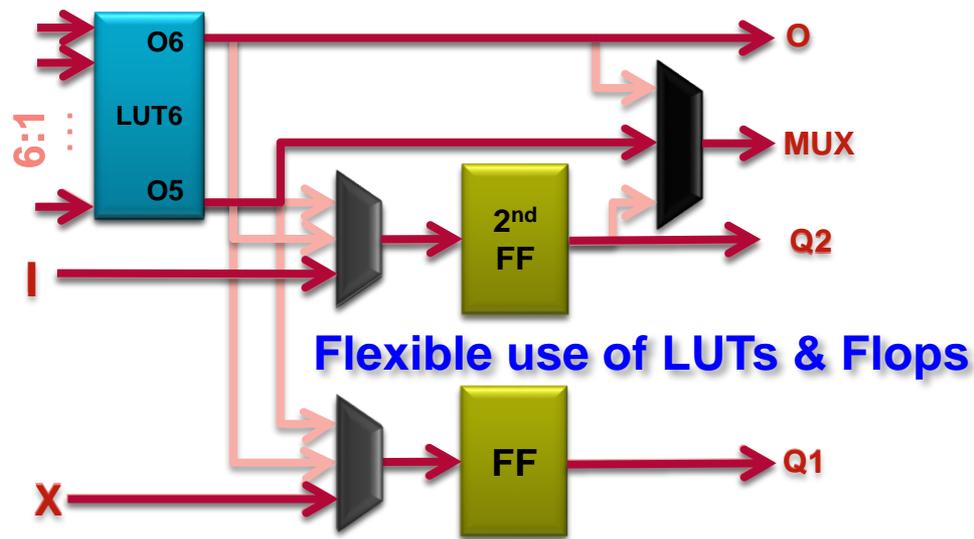
# Flops More Accessible in UltraScale CLB

- Flop and LUT counts unchanged in UltraScale CLB
- Additional input to 2<sup>nd</sup> FF removes dependence on LUT route-thru
- Additional output enables 2<sup>nd</sup> FF independent access to routing

## LUTs and 2 Flops usable simultaneously



7-Series LUT-Flop Pair



UltraScale LUT-Flop Pair

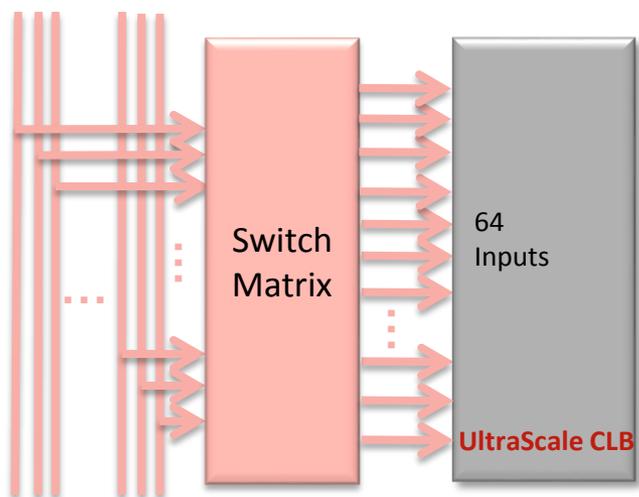
# Effect of Increased Accessibility to Flops

## ➤ Independent access to/from flops

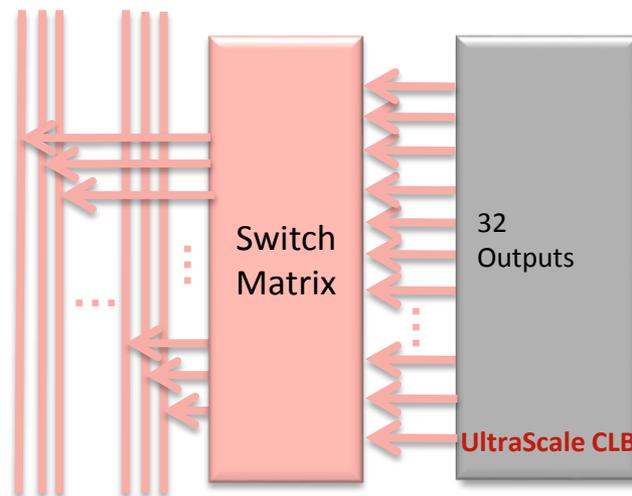
- Input ports increased from 60 to 64
- Output ports increased from 24 to 32

## ➤ *No additional input muxes*

**More CLB flexibility → Borrowed connectivity from Input/Output**



**Re-use of existing multiplexers to serve new inputs**



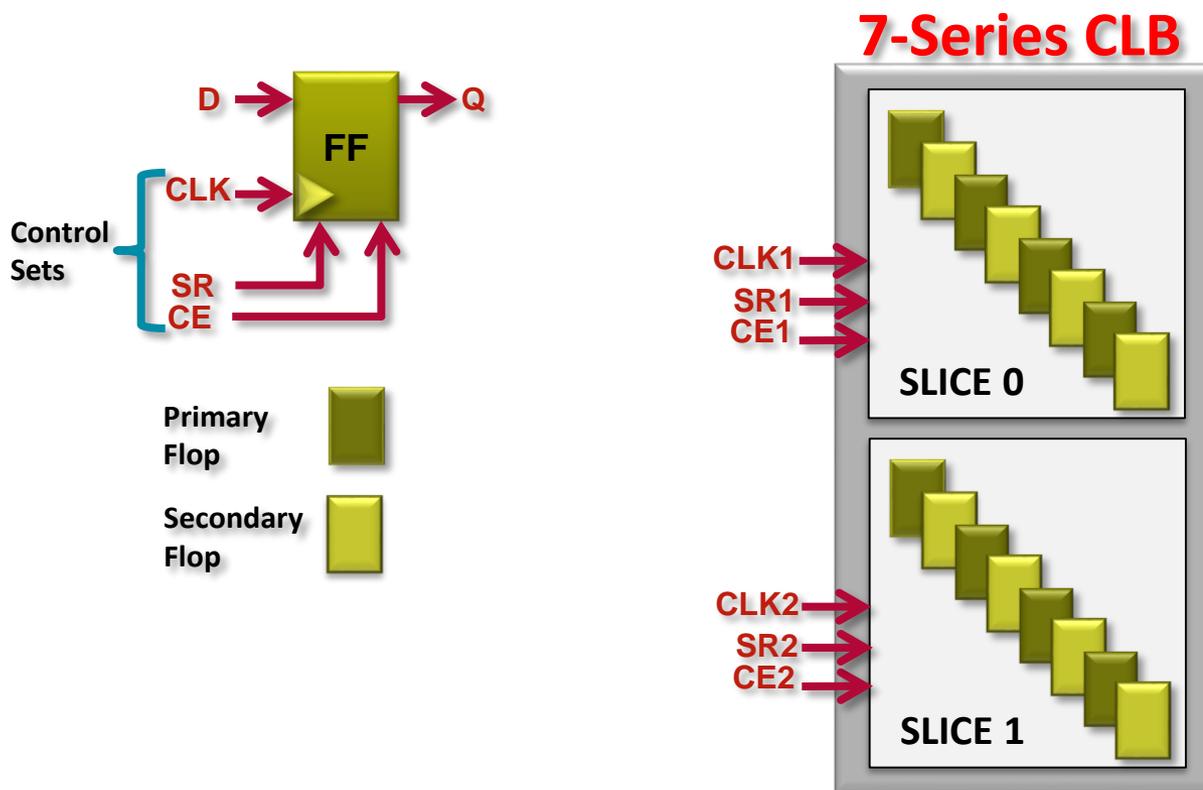
**Proportional reduction in capability of existing outputs**

# Opportunity for improvement in 7-Series CLB

## Make flops more *usable*

- Combination of signals driving Clock, Set/Reset, and CE of a flop
- 7-Series CLB offers 2 Control Sets per CLB

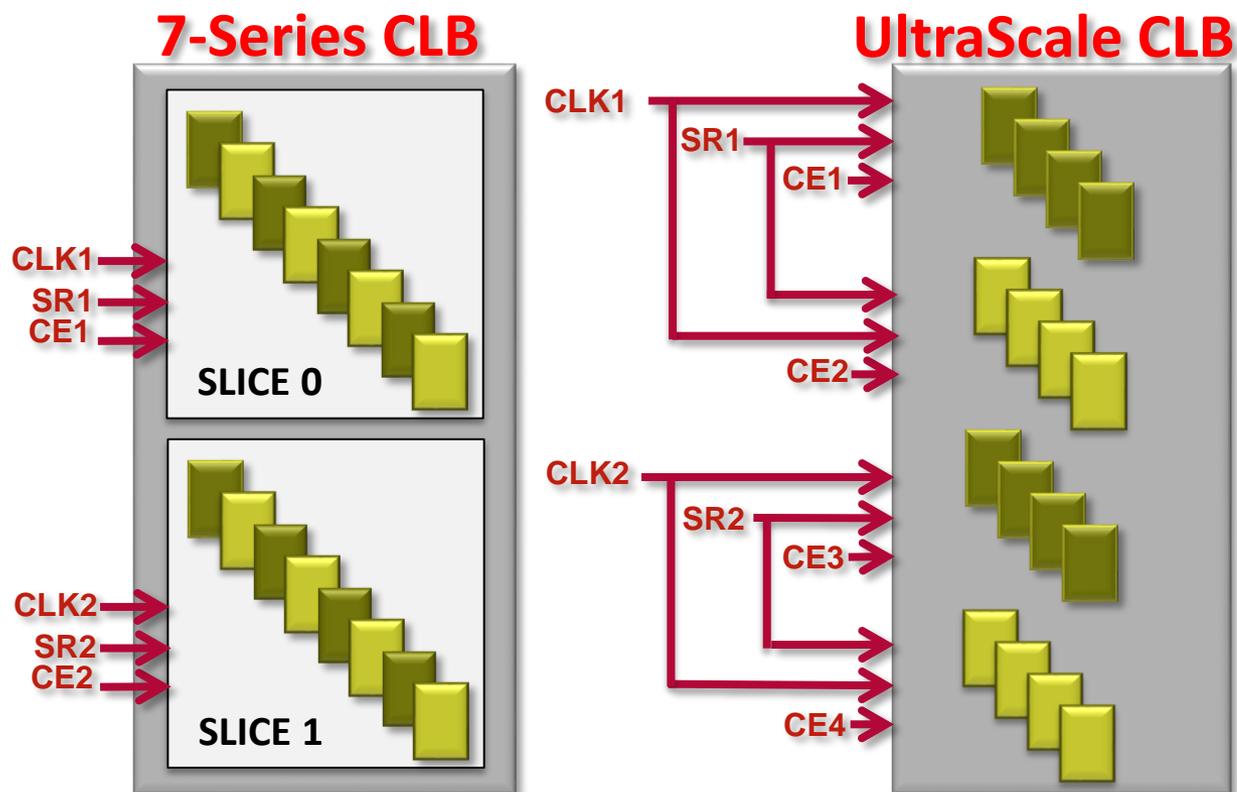
## Control sets limit packing of flops in a CLB



# Flops More Usable in UltraScale CLB

- 2 Extra CEs and 4 Control sets per CLB in UltraScale
- Design's packing is mostly limited by its clock enables

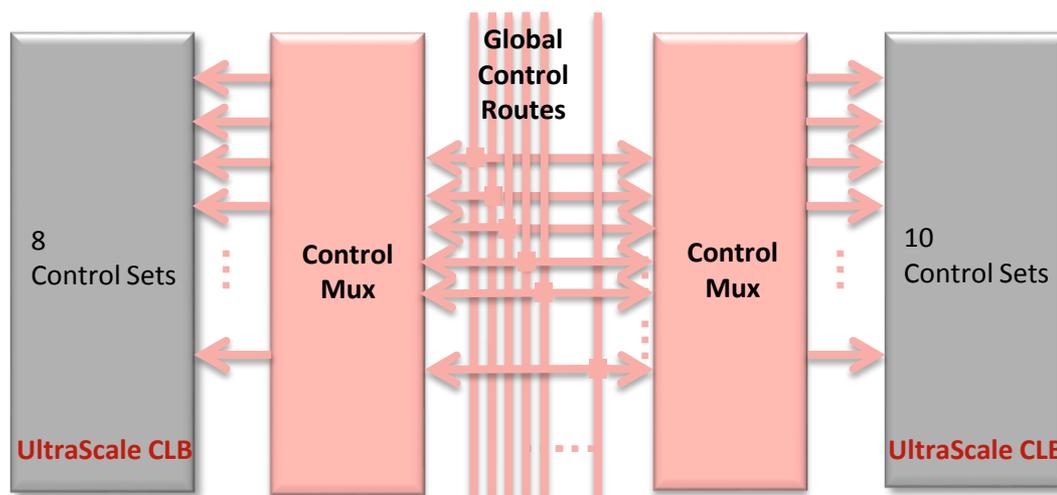
More flops can be packed into UltraScale CLB



# Effect of Increased Usability of Flops

- Global control routes increased from 12 to 16
- Control muxes increased by 5

## Added usability with additional Control Routing and Muxes



# Experimental Setup

# Experimental Setup

## ➤ Used Customer designs and IPs

- 10K to 200K Flops
- 30 K to 160K LUTs
- Also BRAM, DSP, Control Sets
- Wired, Wireless, Video and Audio processing

## ➤ Customers like to “use all CLBs they pay for”

## ➤ Used aggressively packed implementation

- Forces placer to use additional CLB flexibility
- Demonstrates benefit of CLB enhancements

## ➤ Used progressively smaller area constraints

- Discover tightest packing possible

99% LUT  
Utilization



## Premise

➤ UltraScale should handle tighter packing more gracefully

# Experiment Setup

## Isolating effect of CLB enhancements only

### Modifications to design implementation flow

- Designs only placed, to avoid effects of different routing architectures
- Placer does not respond to the routing architecture
- Placer uses identical delay models
- Estimated post-place FMAX

*Show effect of only CLB Changes*

# Results

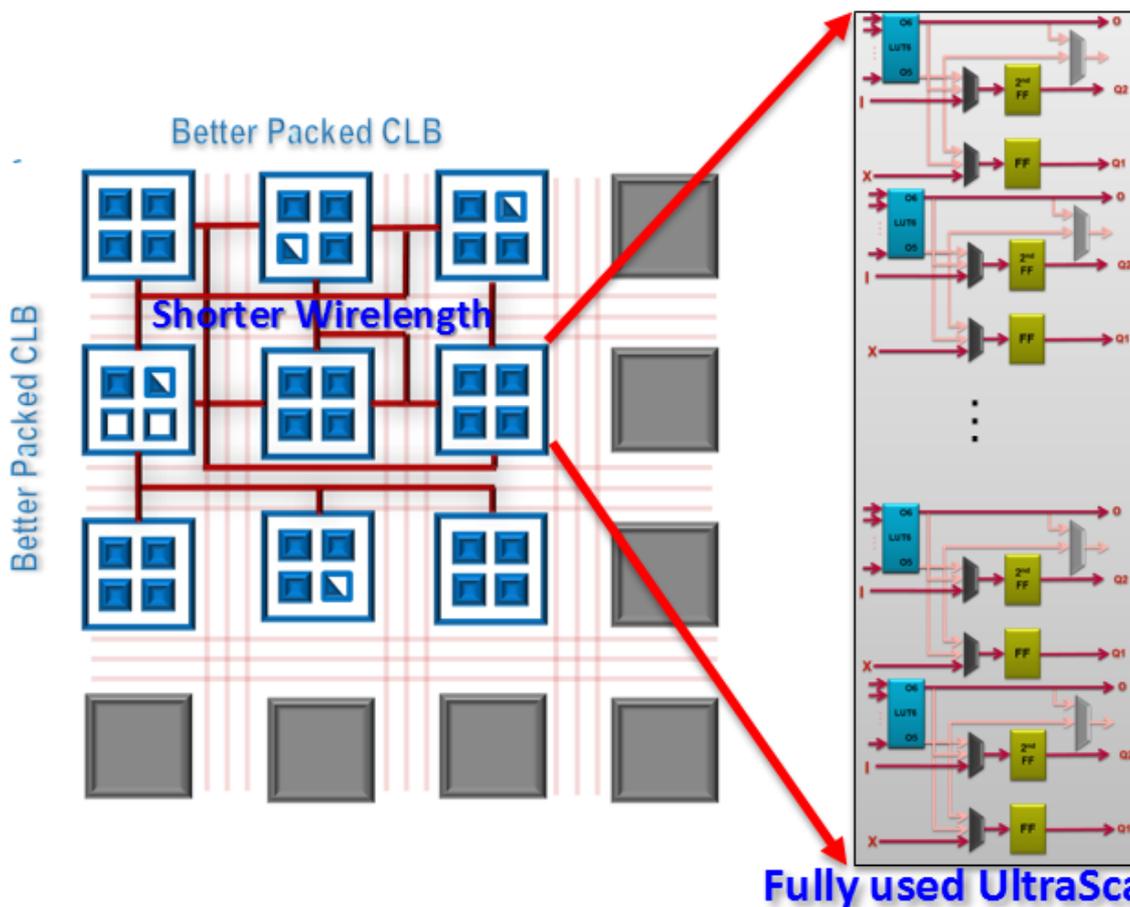
Benefits on Routability, Device Utilization, Performance & Power

# Routability

## ➤ Measure *demand for routing*

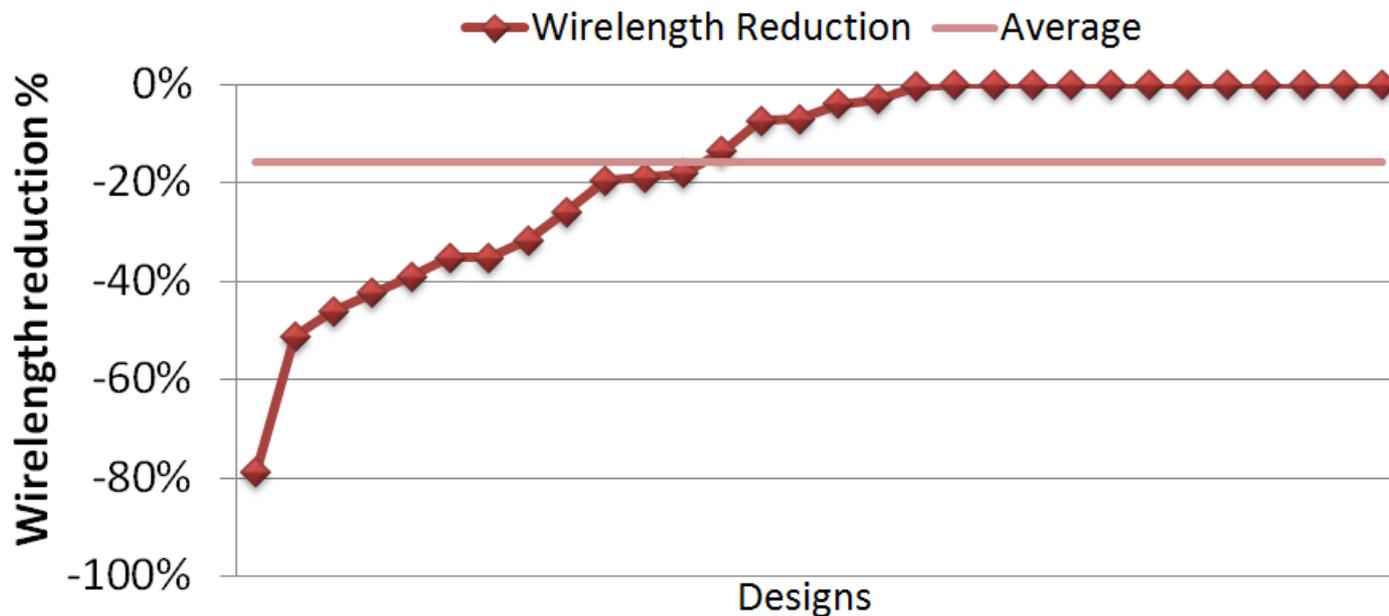
- Predicted through wirelength of the placement
- Wirelength measured in Manhattan bounding box

## ➤ Shorter wirelength with better packing



# Routability

UltraScale Vs 7-Series for same area constraint



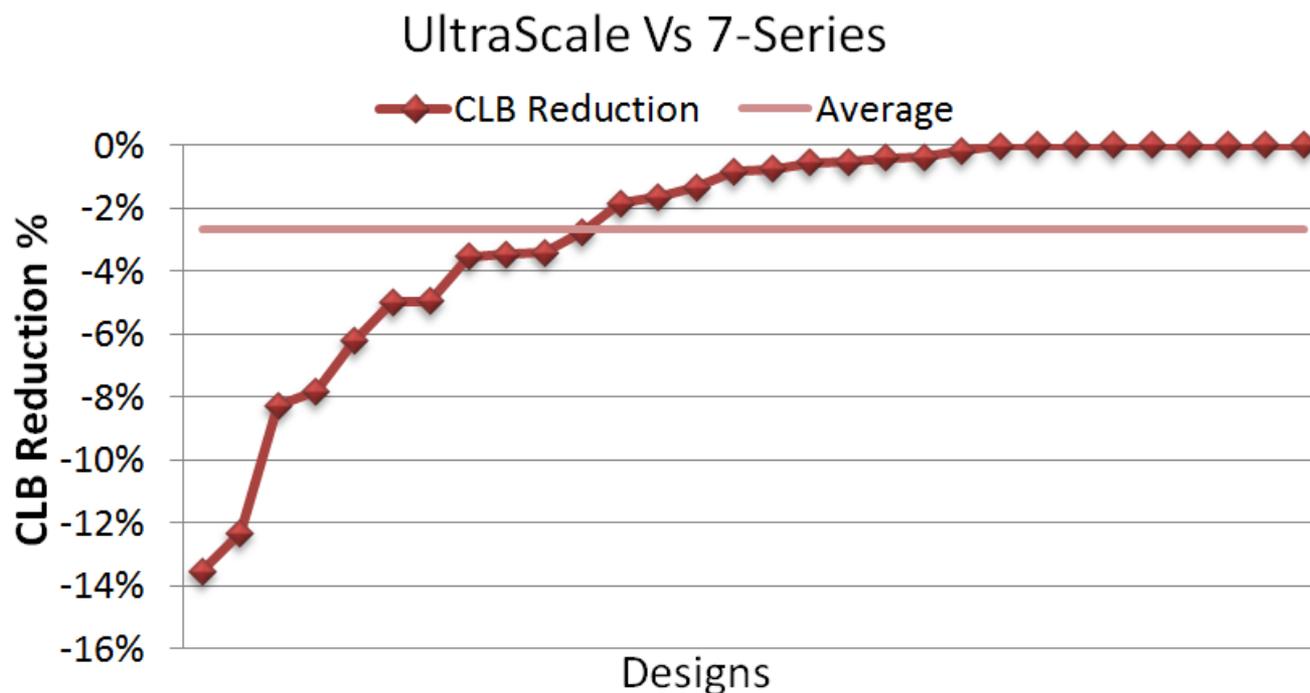
➤ Avg. 16% shorter wirelength than 7-Series

➤ Addresses routability by reducing the demand for routing

➤ Reduced routing demand:

- Reduced routing power dissipation
- Better performance
- Also benefit complex and wider bus design

# Device Utilization



➤ Average: 3% fewer CLBs

➤ Best case: 14% fewer CLBs

➤ Visible savings in more restricted designs

➤ Less savings when:

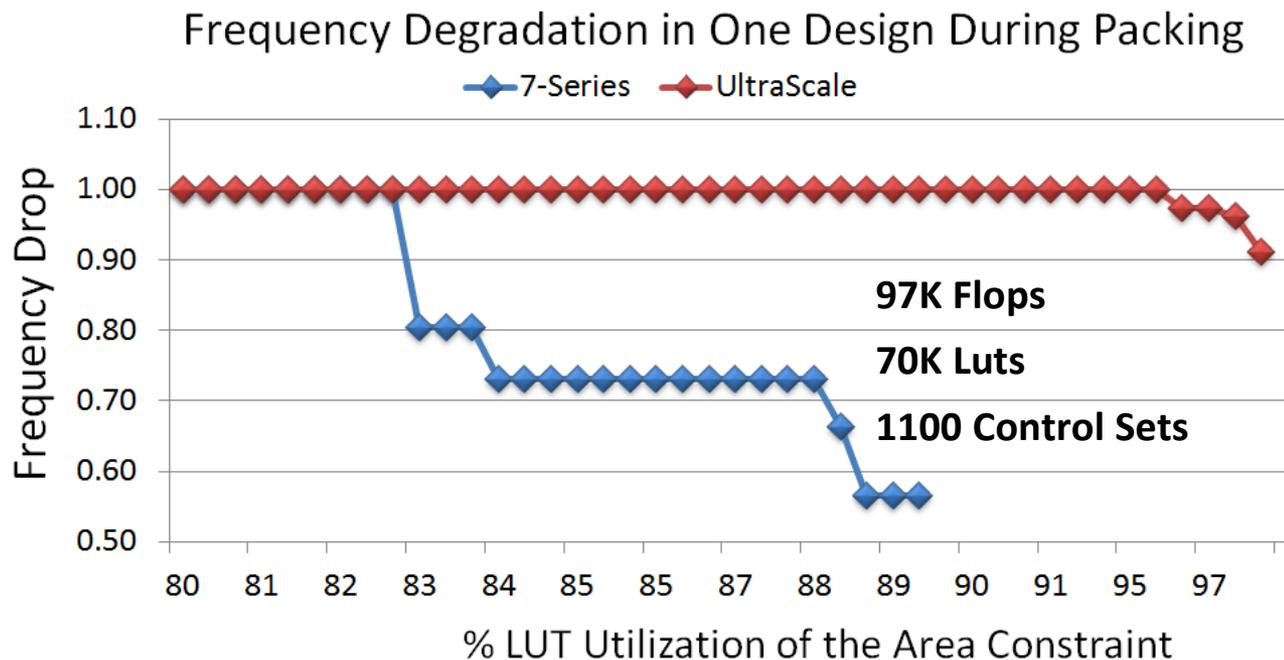
- Fewer flops with independent access
- Fewer control sets
- Fewer LUT merging
- Or, CLB utilization dominated by Carry and Multiplexers

# Device Utilization with Pipelining

**Pipelining data paths will:**

- **Improve performance**
- **More flops with independent access**
- **Even more saving with enhanced access to 2nd FF**

# Performance



➤ Performance vs legal placement trade off

➤ Performance tradeoff determines CLB flexibility

7-Series CLB offers high device utilization, UltraScale offers even higher with less performance degradation

➤ 7-Series

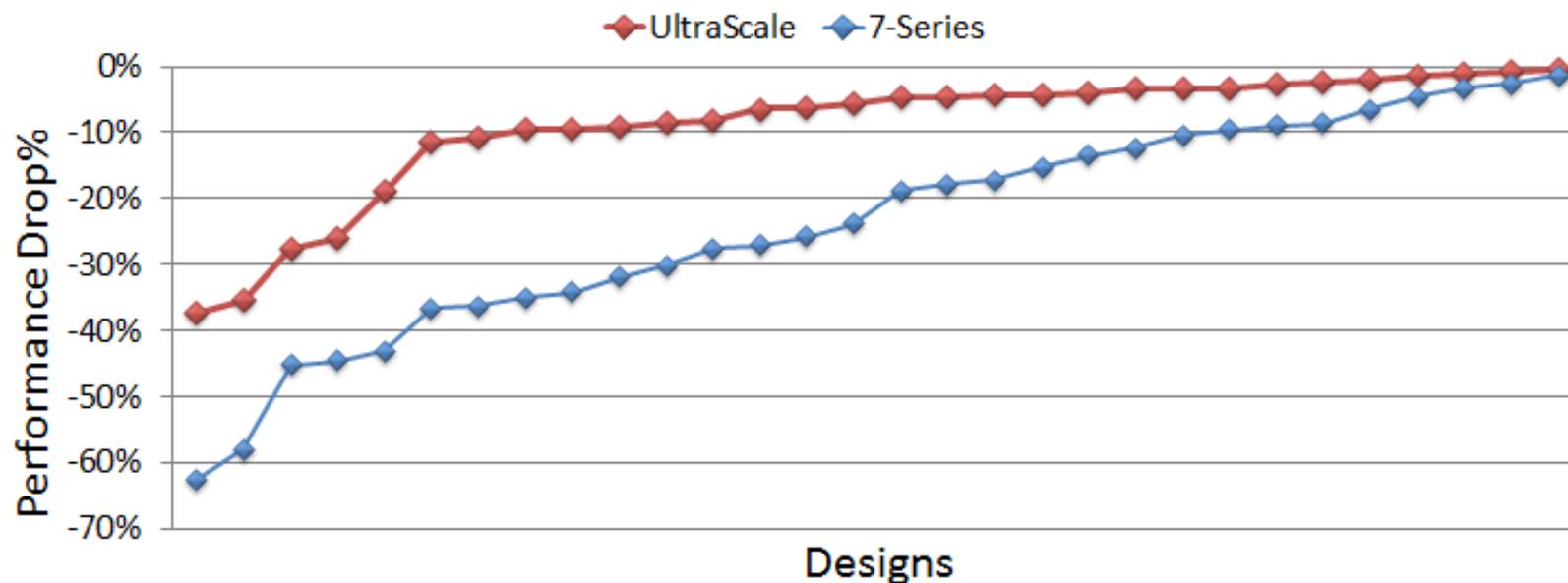
- Supports up to 80% LUT utilization
- Maintain performance within 20%
- Significant improvement over 40nm family

➤ UltraScale

- Close to maximum LUT utilization
- Maintain performance within 12%

# Performance

## UltraScale Vs 7-Series for similar sized area constraints

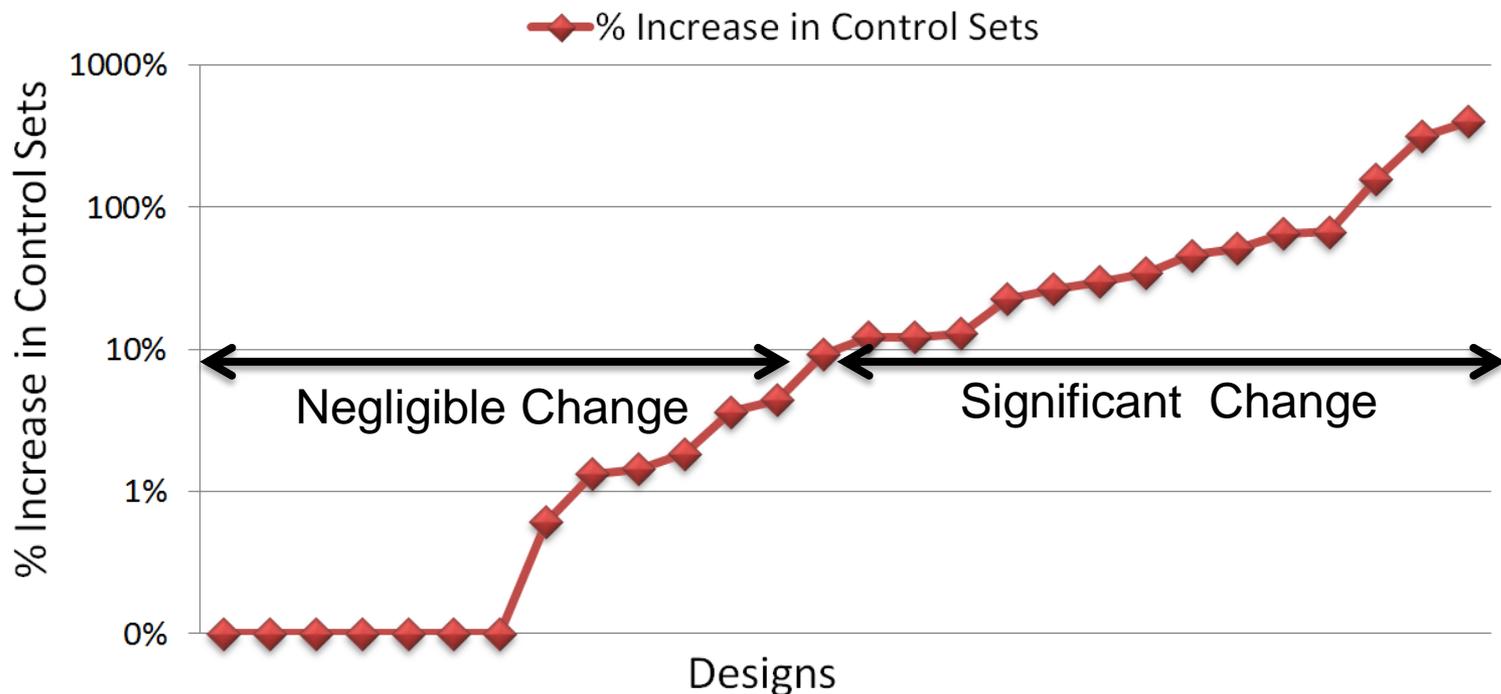


- Average 9% vs 24% performance degradation
- Post placement frequency estimates
- Routing will show routing architecture effects
- Performance trend to sustain even after routing

**UltraScale CLB minimized performance degradation due to tight packing**

# Effects of Power Optimization

## % Increase in Control Sets after Power Optimization



# Conclusion

## ➤ Addressing the challenges of future design:

- Achieve higher bandwidth and maintain routability
- Achieve higher device utilization
- Achieve performance target
- Achieve requisite power budget

## ➤ UltraScale CLB has same number of LUTs and Flops

- It can now use them effectively

## ➤ Addresses the demand of routing resources with a flexible CLB

## ➤ UltraScale CLB is more flexible to handle these challenges

**Thank You!**

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